## DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

my residence, post office address and citizenship are as stated below next to my name;

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: CONFINEMENT DEVICE FOR USE IN DRY ETCHING OF SUBSTRATE SURFACE AND METHOD OF DRY ETCHING A WAFER SURFACE (Docket No. 98-058), the specification of which

	<u>X</u>	is attached here	eto.	
		was filed on Application Seri and was amended	al No	•
	the above		fication, includin	erstand the contents of ag the claims, as amended
	the patent		disclose informati ned in Title 37, Co	on which is material to ode of Federal
	States Coo inventor's any foreig	de, §119(a)-(d) of control of con	of any foreign appl sted below and have or patent or invent	der Title 35, United dication(s) for patent or also identified below cor's certificate having a on which priority is
	Prior Fore	eign Application	(s)	Priority Claimed
-	(Number)	(Country) (Day,	/Month/Year Filed)	Yes No
	T 11		7	

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application: None

And I hereby appoint:

O

<u>David G. Pursel</u> of Milpitas, California, Registration No. <u>28,659</u>
<u>Ralph Veseli</u> of Milpitas, California, Registration No. <u>33,807</u>
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as my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. I hereby expressly waive my right to revoke the Power of Attorney granted above. Address all telephone calls to Wayne P. Bailey at telephone number (970) 206-5467. Address all correspondence to Wayne P. Bailey, Law Department, LSI Logic Corporation, 2001 Danfield Court, Fort Collins, Colorado 80525.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's signature Name W. Jurgensen Date: 12/17/98

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valid OMB control number.

Patent and Trademark Office: U.S. DEPARTMENT OF Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a

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Application Number	09/228,906					
Filing Date	January-11, 1999					
First Named Inventor	Charles W. Jurgensen					
Group Art Unit	1763					
Examiner Name	Alva Powell					
Attorney Docket Number	SYM/LSI-105A / 98-058					

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